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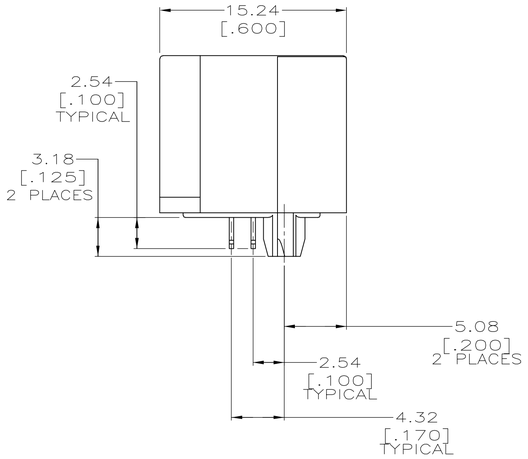
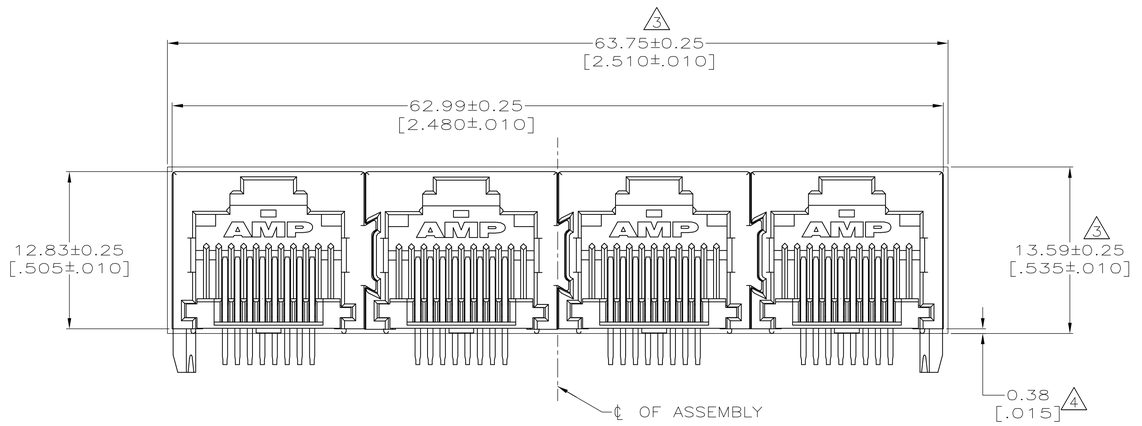
LOC	DIST
AA	22

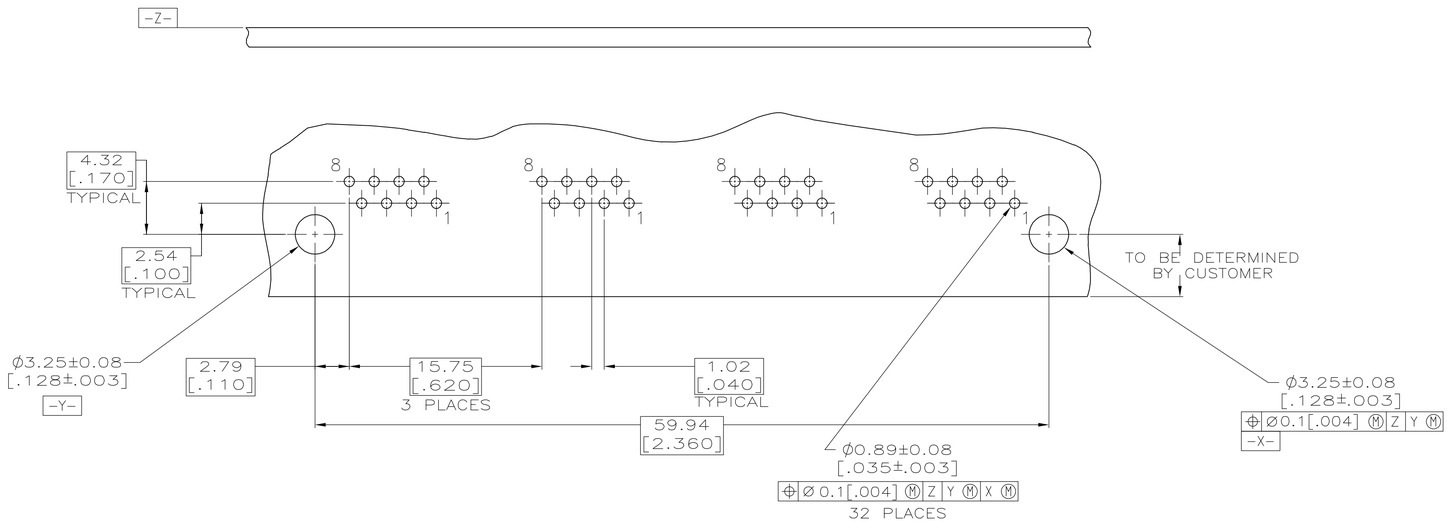
REVISIONS

P	LTR	DESCRIPTION	DATE	DWN	APVD
	A	REV PER EC 0S11-0201-04	10JUN2005	JA	SF





1. MATERIAL:
   HOUSING – HIGH TEMPERATURE THERMOPLASTIC, BLACK, UL94V-0; IR REFLOW SOLDERING PROCESS COMPATIBLE.
   TERMINALS – .36[.014] THICK PHOS BRONZE PLATED WITH 3.81µm[.000150] MINIMUM THICK MATTE TIN IN SOLDER AREA. 1.27µm [.000050] MINIMUM GOLD IN LOCALIZED PLATE AREA. ENTIRE TERMINAL PLATED WITH 1.27µm [.000050] MINIMUM THICK NICKEL.
2. JACK CAVITY CONFORMS TO FCC RULES AND REGULATIIONS PART 68, SUBPART F.
3. SUGGESTED PANEL OPENING DIMENSIONS.
4. SUGGESTED CLEARANCE BETWEEN BOTTOM OF CONNECTOR AND BOTTOM PANEL OPENING.



SUGGESTED PRINTED CIRCUIT BOARD LAYOUT
(COMPONENT SIDE)

5406528-1
PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.

DIMENSIONS: mm[inches]

TOLERANCES UNLESS OTHERWISE SPECIFIED:
0 PLC ± –
1 PLC ± –
2 PLC ± –
3 PLC ± –
4 PLC ± –
ANGLES ± –

MATERIAL 1
FINISH –

DWN 10JUN2005 J. ALCORTA – DOCKS
CHK 10JUN2005 J. WESTMAN
APVD 10JUN2005 S. FLICKINGER
PRODUCT SPEC 108-1163-4
APPLICATION SPEC 114-2154
WEIGHT –

Tyco Electronics Corporation
Harrisburg, PA 17105-3608

NAME INVERTED MOD JACK ASSEMBLY, 1x4

SIZE	CAGE CODE	DRAWING NO	RESTRICTED TO
A1	–	C-5406528	–

CUSTOMER DRAWING | SCALE 4:1 | SHEET 1 OF 1 | REV A